
HM62W8127H Series

HM62W9127H Series

131072-word \times 8/9-bit High Speed CMOS Static RAM

HITACHI

Description

The HM62W8127H/HM62W9127H is an asynchronous 3.3 V operation high speed static RAM organized as 131,072-word \times 8/9-bit. It realize high speed access time (30/35/45 ns) with employing 0.8 μm CMOS process and high speed circuit designing technology. It is most appropriate for the application which requires high speed, high density memory and wide bit width configuration, such as cache and buffer memory in system. The HM62W8127H/HM62W9127H is packaged in 400-mil 32/36-pin SOJ for high density surface mounting.

Features

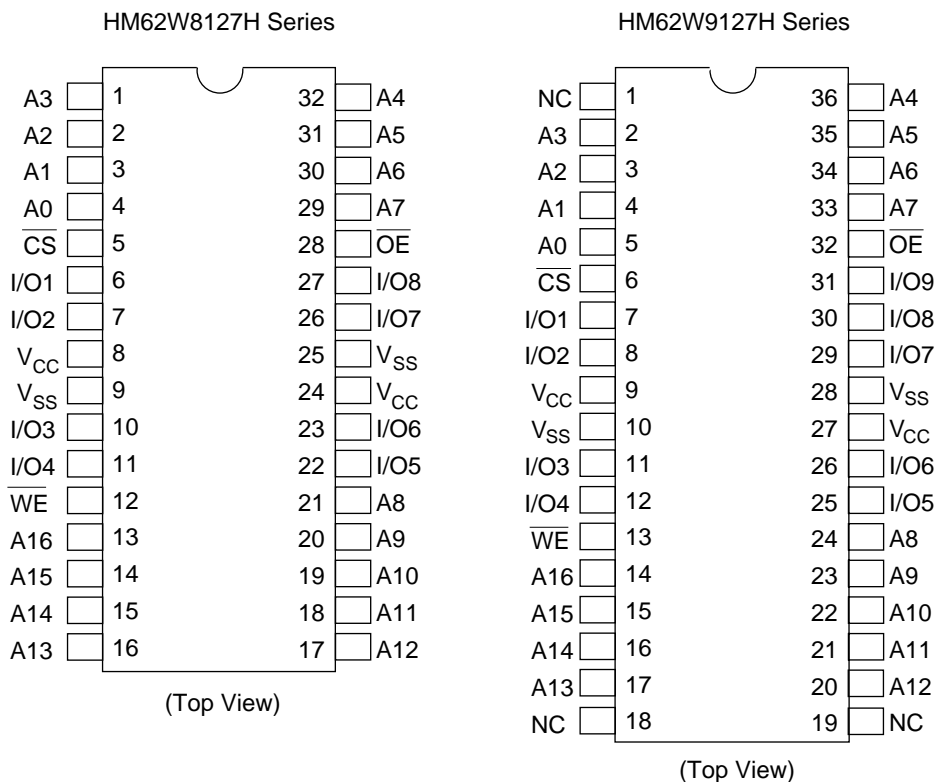
- Single 3.3 V supply: 3.3 V \pm 0.3 V
- Access time 30/35/45 ns (max)
- Completely static memory
 - No clock or timing strobe required
- Equal access and cycle times
- Directly CMOS compatible
 - All inputs and outputs
- 400-mil 32/36-pin SOJ package
- Center V_{CC} and V_{SS} type pinout

HM62W8127H/HM62W9127H Series

Ordering Information

Type No.	Access Time	Package
HM62W8127HJP-30	30 ns	400-mil 32-pin plastic SOJ (CP-32DB)
HM62W8127HJP-35	35 ns	
HM62W8127HJP-45	45 ns	
HM62W8127HLJP-30	30 ns	
HM62W8127HLJP-35	35 ns	
HM62W8127HLJP-45	45 ns	
HM62W9127HJP-30	30 ns	400-mil 36-pin plastic SOJ (CP-36D)
HM62W9127HJP-35	35 ns	
HM62W9127HJP-45	45 ns	
HM62W9127HLJP-30	30 ns	
HM62W9127HLJP-35	35 ns	
HM62W9127HLJP-45	45 ns	

Pin Arrangement

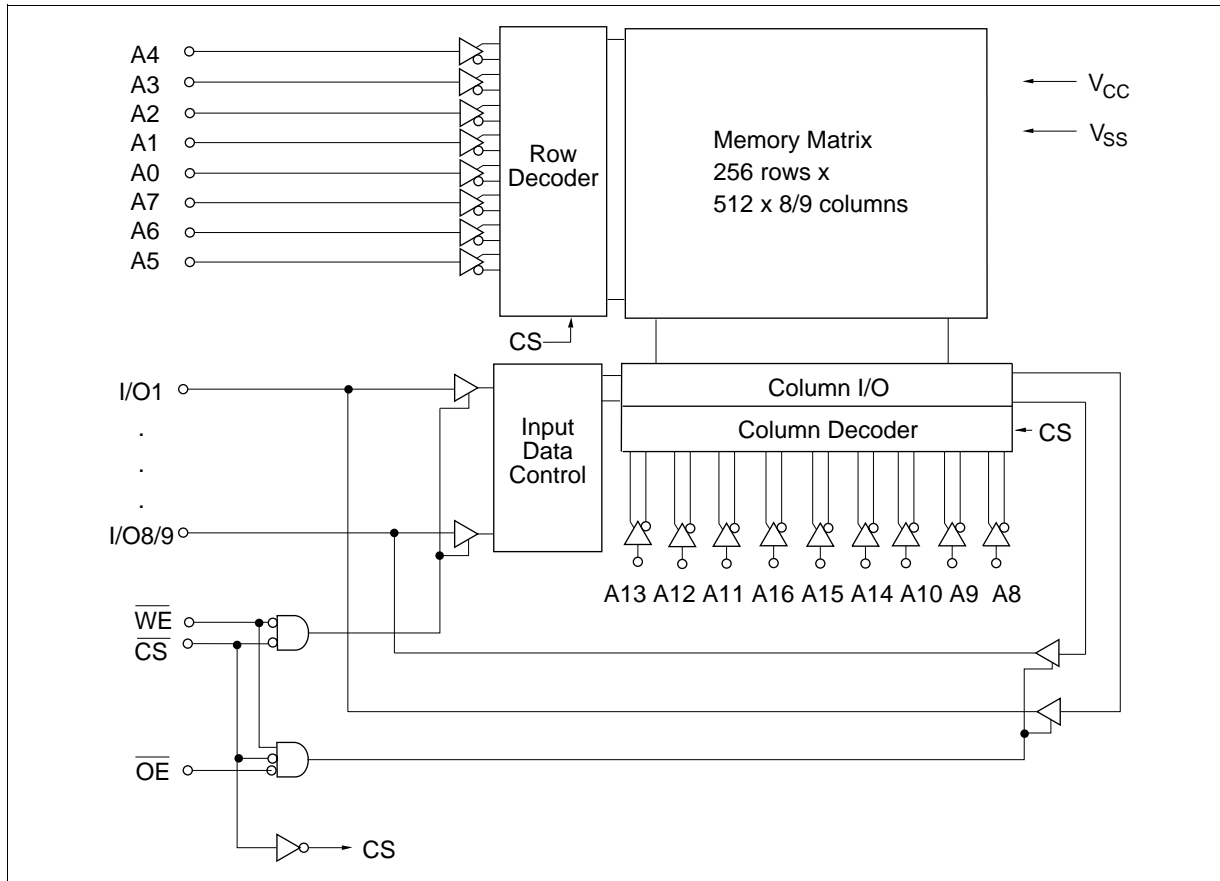


Pin Description

Pin Name

HM62W8127H	HM62W9127H	Function
A0 – A16	A0 – A16	Address
I/O1 – I/O8	I/O1 – I/O9	Data input/output
\overline{CS}	\overline{CS}	Chip select
\overline{WE}	\overline{WE}	Write enable
\overline{OE}	\overline{OE}	Output enable
V_{CC}	V_{CC}	Power supply
V_{SS}	V_{SS}	Ground
—	NC	No connection

Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Supply voltage relative to V _{SS}	V _{CC}	-0.5 to +4.6	V
Voltage on any pin relative to V _{SS}	V _T	-0.5 ¹⁾ to V _{CC} + 0.5	V
Power dissipation	P _T	1.0	W
Operating temperature	T _{opr}	0 to +70	°C
Storage temperature	T _{stg}	-55 to +125	°C
Storage temperature under bias	T _{bias}	-10 to +85	°C

Note: 1. -2.5 V for pulse width (under shoot) ≤ 10 ns

Function Table

\overline{CS}	\overline{OE}	\overline{WE}	V_{CC} Current	I/O	Ref. Cycle
H	X	X	I_{SB}, I_{SB1}	High-Z	—
L	H	H	I_{CC}	High-Z	—
L	L	H	I_{CC}	Output	Read cycle
L	X	L	I_{CC}	Input	Write cycle

Note: X: H or L

Recommended DC Operating Conditions (Ta = 0 to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage ²	V_{CC}	3.0	3.3	3.6	V
	V_{SS}	0	0	0	V
Input voltage	V_{IH}	2.0	—	$V_{CC} + 0.3$	V
	V_{IL}	-0.3 ¹	—	0.8	V

- Notes: 1. -2.0 V for pulse width (under shoot) ≤ 10 ns
 2. The supply voltage with all V_{CC} pins must be on the same level.
 The supply voltage with all V_{SS} pins must be on the same level.

HM62W8127H/HM62W9127H Series

DC Characteristics (Ta = 0 to +70°C, V_{CC} = 3.3 V ± 0.3 V, V_{SS} = 0 V)

Parameter	Symbol	Min	Typ ¹	Max	Unit	Test Conditions	Note
Input leakage current	I _{LI}	—	—	2	μA	V _{in} = V _{SS} to V _{CC}	
Output leakage current	I _{LO}	—	—	2	μA	V _{I/O} = V _{SS} to V _{CC}	
Operating power supply current	I _{CC}	—	50	90	mA	30 ns cycle	CS = V _{IL} , I _{out} = 0 mA Other inputs = V _{IH} /V _{IL}
			45	85	mA	35 ns cycle	
			40	80	mA	45 ns cycle	
Standby power supply current	I _{SB}	—	18	35	mA	30 ns cycle	CS = V _{IH} , Other inputs = V _{IH} /V _{IL}
			15	30	mA	35 ns cycle	
			13	25	mA	45 ns cycle	
Standby power supply current (1)	I _{SB1}	—	—	1	mA	V _{CC} ≥ CS ≥ V _{CC} - 0.2 V, 0 V ≤ V _{in} ≤ 0.2 V or V _{CC} ≥ V _{in} ≥ V _{CC} - 0.2 V	
				—	—	0.15	mA
Output voltage	V _{OL1}	—	—	0.2	V	I _{OL1} = 0.1 mA	
	V _{OL2}	—	—	0.4	V	I _{OL2} = 2 mA	
	V _{OH1}	V _{CC} - 0.2	—	—	V	I _{OH1} = -0.1 mA	
	V _{OH2}	2.4	—	—	V	I _{OH2} = -2 mA	

Note: 1. Typical values are at V_{CC} = 3.3 V, Ta = +25°C and not guaranteed.

Capacitance (Ta = 25°C, f = 1.0 MHz)^{*1}

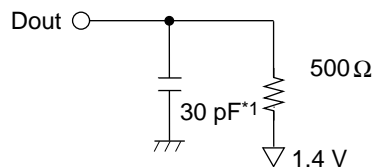
Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Input capacitance	C _{in}	—	—	6	pF	V _{in} = 0 V
Input/output capacitance	C _{I/O}	—	—	8	pF	V _{I/O} = 0 V

Note: 1. This parameter is sampled and not 100% tested.

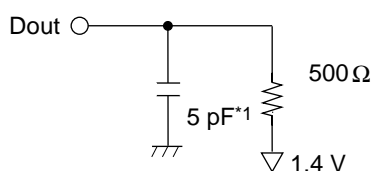
AC Characteristics (Ta = 0 to +70°C, V_{CC} = 3.3 V ± 0.3 V, unless otherwise noted.)

Test Conditions

- Input pulse levels: 2.4 V/0.4 V
- Input rise and fall time: 3 ns
- Input and output timing reference level: 1.4 V
- Output load: See figures



Output load (A)
Note: 1. Including scope and jig



Output load (B)
(for t_{CLZ}, t_{OLZ}, t_{CHZ}, t_{OHZ}, t_{WHZ}, and t_{OW})

Read Cycle

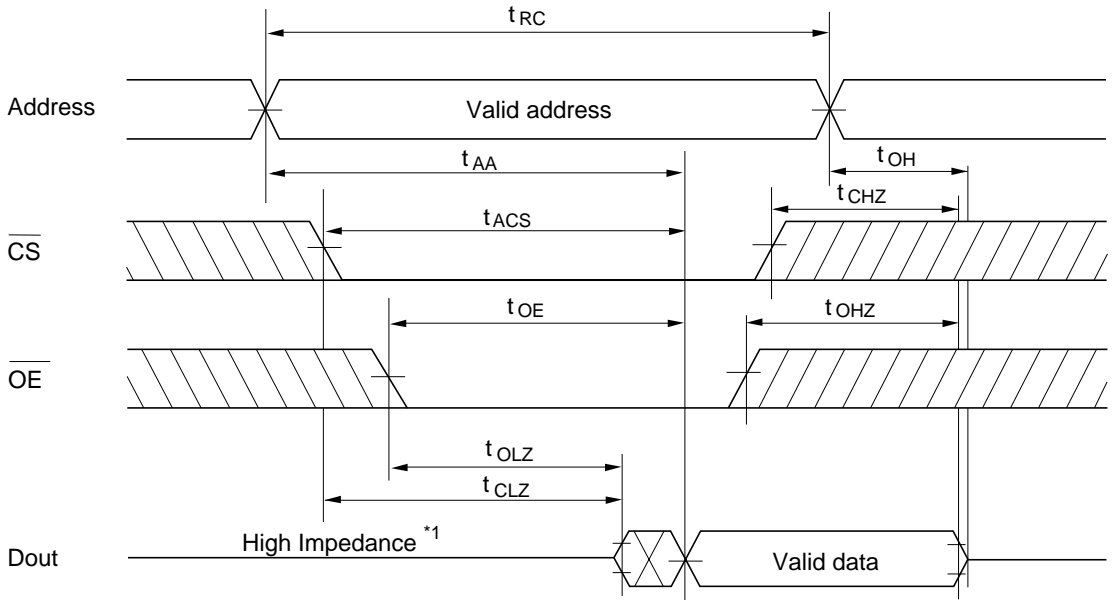
HM62W8127H/HM62W9127H

Parameter	Symbol	-30		-35		-45		Unit	Note
		Min	Max	Min	Max	Min	Max		
Read cycle time	t _{RC}	30	—	35	—	45	—	ns	
Address access time	t _{AA}	—	30	—	35	—	45	ns	
Chip select access time	t _{ACS}	—	30	—	35	—	45	ns	
Output enable to output valid	t _{OE}	—	15	—	20	—	25	ns	
Output hold from address change	t _{OH}	5	—	5	—	5	—	ns	
Chip select to output in low-Z	t _{CLZ}	5	—	5	—	5	—	ns	1
Output enable to output in low-Z	t _{OLZ}	1	—	1	—	1	—	ns	1
Chip deselect to output in high-Z	t _{CHZ}	—	12	—	12	—	12	ns	1
Output disable to output in high-Z	t _{OHZ}	—	12	—	12	—	12	ns	1

Note: 1. Transition is measured ±200 mV from steady voltage with Load (B). This parameter is sampled and not 100% tested.

HM62W8127H/HM62W9127H Series

Read Timing Waveform ($\overline{WE} = V_{IH}$)



Note: 1. When \overline{CS} and \overline{OE} are low, Dout is low impedance. ^{*1}

Write Cycle ^{*1}

		HM62W8127H/HM62W9127H							
		-30		-35		-45			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Write cycle time	t_{WC}	30	—	35	—	45	—	ns	
Address valid to end of write	t_{AW}	20	—	25	—	30	—	ns	
Chip select to end of write	t_{CW}	20	—	25	—	30	—	ns	
Write pulse width	t_{WP}	20	—	25	—	30	—	ns	
Address setup time	t_{AS}	0	—	0	—	0	—	ns	2
Write recovery time	t_{WR}	0	—	0	—	0	—	ns	3
Data to write time overlap	t_{DW}	15	—	20	—	25	—	ns	
Data hold from write time	t_{DH}	0	—	0	—	0	—	ns	
Write disable to output in low-Z	t_{OW}	5	—	5	—	5	—	ns	4
Write enable to output in high-Z	t_{WHZ}	—	12	—	12	—	12	ns	4

Notes: 1. A write occurs during the overlap of low \overline{CS} , low \overline{WE} .

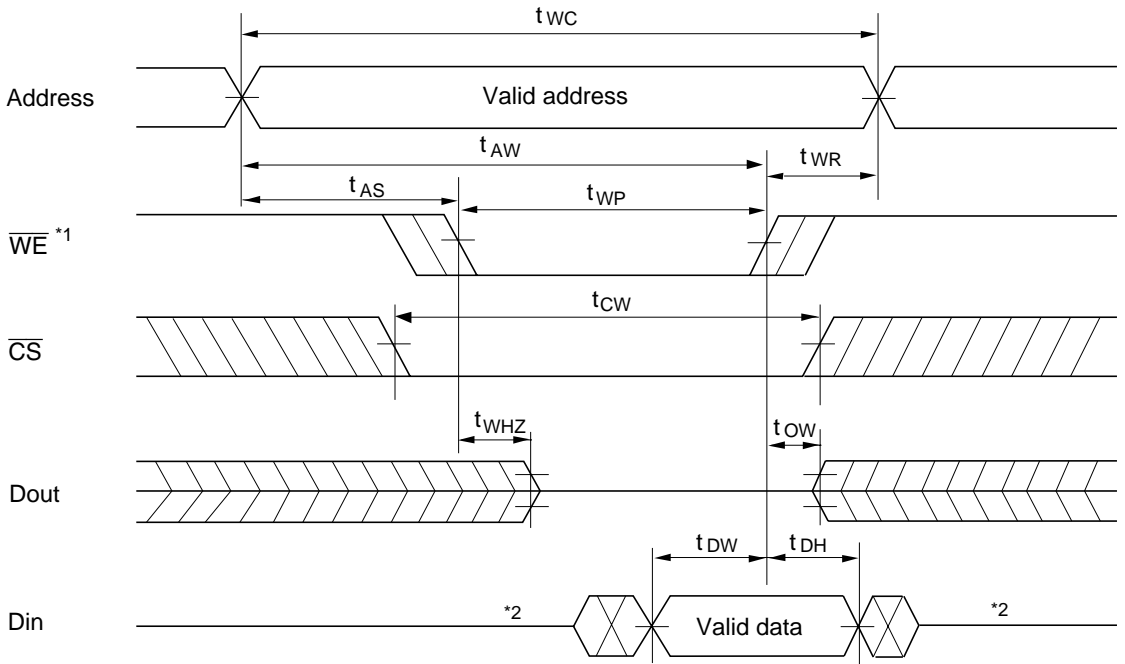
2. t_{AS} is measured from the latest address transition to the later of \overline{CS} or \overline{WE} going low.

3. t_{WR} is measured from the earliest of \overline{CS} or \overline{WE} going high to the first address transition.

4. Transition is measured ± 200 mV from high impedance state's voltage with Load (B). This parameter is sampled and not 100% tested.

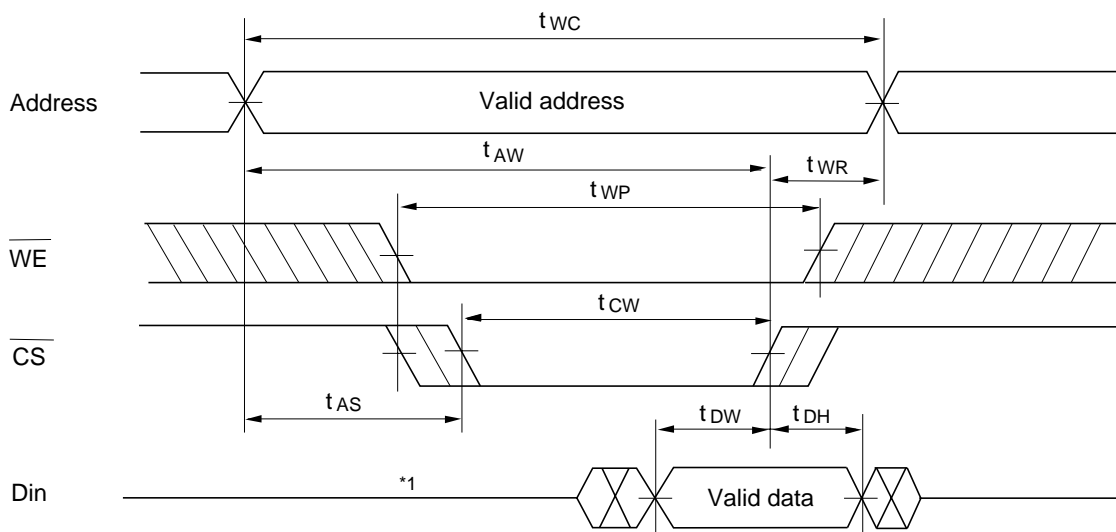
HM62W8127H/HM62W9127H Series

Write Timing Waveform (1) (\overline{WE} Controlled)



- Notes:
1. \overline{WE} must be high during address transition except when the device is disabled with \overline{CS} .
 2. If \overline{CS} and \overline{OE} are low during this period, I/O pins are in the output state. Then, the data input signals of opposite phase to the outputs must not be applied to them.

Write Timing Waveform (2) (\overline{CS} Controlled)



Note: 1. If the \overline{CS} low transition occurs simultaneously with the \overline{WE} low transition or after the \overline{WE} transition, output remains a high impedance state.

HM62W8127H/HM62W9127H Series

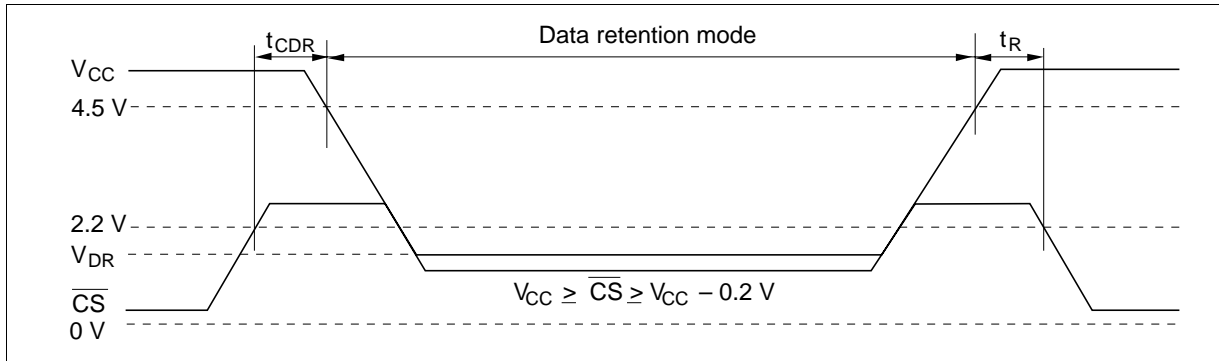
Low V_{CC} Data Retention Characteristics ($T_a = 0$ to $+70^\circ\text{C}$)

This characteristics is guaranteed only for L-version.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
V_{CC} for data retention	V_{DR}	2.0	—	—	V	$V_{CC} \geq \overline{CS} \geq V_{CC} - 0.2$ V, $V_{CC} \geq V_{in} \geq V_{CC} - 0.2$ V or 0 V $\leq V_{in} \leq 0.2$ V
Data retention current	I_{CCDR}	—	2	80^{*1}	μA	
Chip deselect to data retention time	t_{CDR}	0	—	—	ns	
Operation recovery time	t_R	5	—	—	ms	

Note: 1. $V_{CC} = 3.0$ V

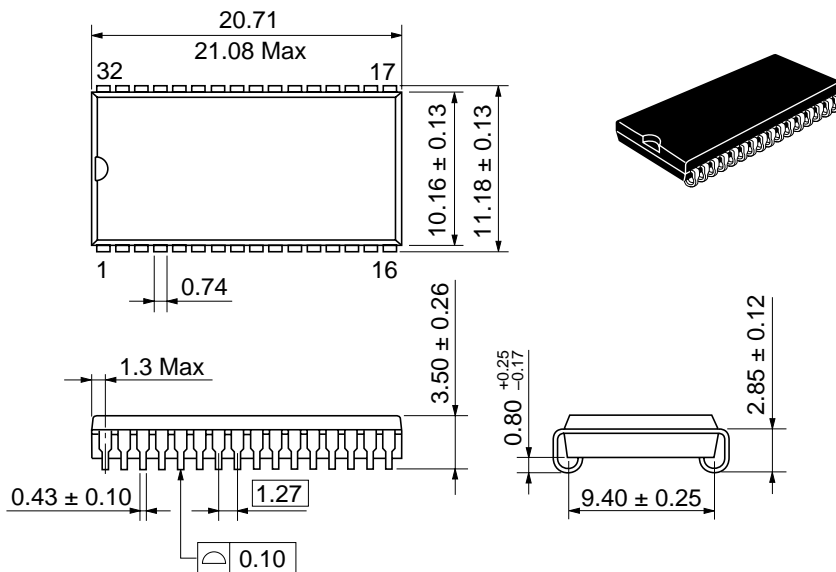
Low V_{CC} Data Retention Timing Waveform



Package Dimensions

HM62W8127HJP/HLJP Series (CP-32DB)

Unit: mm



HM62W9127HJP/HLJP Series (CP-36D)

Unit: mm

